



OLED SPECIFICATION

Model No:

REX012832KWPP3N00000

CUSTOMER:

APPROVED BY	
PCB VERSION	
DATE	

FOR CUSTOMER USE ONLY

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 \square APPROVAL FOR SPECIFICATIONS AND SAMPLE



1. Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2018/06/29		First release



Contents

- 1.General Specification
- 2. Module Classification Information
- 3.Interface Pin Function
- 4. Contour Drawing & Block Diagram
- 5. Absolute Maximum Ratings
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- 8.OLED Lifetime
- 9.Reliability
- 10.Inspection specification
- 11.Precautions in use of OLED Modules



1.General Specification

The Features is described as follow:

■ Module dimension: 59.0 x 18.86 x 1.41 mm

Active area: 50.535 ×10.695 mm

■ Dot Matrix: 128 x 32

Pixel size: 0.370 x 0.310 mm
 Pixel pitch: 0.395 x 0.335 mm
 Display Mode: Passive Matrix

■ Duty: 1/32 Duty

■ Display Color: White

■ IC: SSD1315

■ Interface: 8Bits 68xx 80xx/ SPI/ I2C

■ Size: 2.0 inch



2. Module Classification information

1	2	3	4	5	6	7	8	9	10	11	12	13	14
R	Е	Х	012832	K	W	Р	Р	3	N	0	0	0	00

2	1	Brand : Raystar Optronics Inc.						
Display Type X : COG	2	E: OLED	: OLED					
4 Dot Matrix: 128*32 5 Series A: Amber R: Red C: Full Color B: Blue W: White G: Green Y: Yellow S: Sky Blue X: Dual Color P: With Polarizer, N: Without Polarizer A: Anti-glare Polarizer Bisplay Mode P: Passive Matrix; N: Active Matrix Driver Voltage 3: 3.0~3.3V; 5: 5.0V Touch Panel N: Without touch panel; T: With touch panel Product type 0: Standard 1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting D: Standard 2: B grade C: Automotive grade Y: Consumer grade 13 Option 0: Default; F: ZIF FPC; H: Hot bar FPC; D: Demo Kit	3	Display Type	X : (COG COG + FR + PCB		H: COG + FR		
A: Amber R: Red C: Full Color B: Blue W: White G: Green Y: Yellow S: Sky Blue X: Dual Color Polarizer Polarizer N: Without Polarizer A: Anti-glare Polarizer Bisplay Mode P: Passive Matrix; N: Active Matrix Diriver Voltage S: 3.0~3.3V; 5: 5.0V N: Without touch panel; T: With touch panel Product type O: Standard S: Texplay Readable S: Transparent OLED (TOLED) S: Flexible OLED (FOLED) S: Flexible OLED (FOLED) S: Standard S: B grade C: Automotive grade Y: Consumer grade O: Default; F: ZIF FPC; H: Hot bar FPC; D: Demo Kit	4	Dot Matrix: 1						
B: Blue W: White G: Green Y: Yellow S: Sky Blue X: Dual Color Polarizer P: With Polarizer; N: Without Polarizer A: Anti-glare Polarizer B: Display Mode P: Passive Matrix; N: Active Matrix Driver Voltage S: 3.0~3.3V; 5:5.0V Touch Panel N: Without touch panel; T: With touch panel Product type P: Vithout touch panel; T: With touch panel Till Product type S: Transparent OLED (TOLED) S: Flexible OLED (FOLED) S: Flexible OLED (FOLED) S: Standard C: Automotive grade Y: Consumer grade Till Product S: B grade C: Automotive grade C: Automotive grade C: Automotive grade C: Option S: Default; F: ZIF FPC; H: Hot bar FPC; D: Demo Kit	5	Series			/WID 1110	I		
A: Anti-glare Polarizer B Display Mode P: Passive Matrix; N: Active Matrix Driver Voltage 3: 3.0~3.3V; 5: 5.0V Touch Panel N: Without touch panel; T: With touch panel Product type 0: Standard 1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: B grade C: Automotive grade Y: Consumer grade 13 Option 0: Default; F: ZIF FPC; H: Hot bar FPC; D: Demo Kit	6	Emitting Color		B: Blue G: Green	W: White Y: Yellow	C : Full Color		
9 Driver Voltage 3:3.0~3.3V; 5:5.0V 10 Touch Panel N: Without touch panel; T: With touch panel 11 Product type 0: Standard 1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: B grade C: Automotive grade Y: Consumer grade 13 Option 0: Default; F: ZIF FPC; H: Hot bar FPC; D: Demo Kit	7	Polarizer		/ W		zer		
10 Touch Panel N: Without touch panel; T: With touch panel 11 Product type 12 Inspection Grade 13 Option N: Without touch panel; T: With touch panel 0: Standard 1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: B grade C: Automotive grade Y: Consumer grade 0: Default; F: ZIF FPC; H: Hot bar FPC; D: Demo Kit	8	Display Mode)	P: Passive Matrix;	; N: Active Matrix	x		
Product type 0 : Standard 1 : Daylight Readable 2 : Transparent OLED (TOLED) 3 : Flexible OLED (FOLED) 4 : OLED Lighting 0 : Standard 2 : B grade C : Automotive grade Y : Consumer grade 13 Option 0 : Default ; F : ZIF FPC ; H : Hot bar FPC; D : Demo Kit	9	Driver Voltage	4	3:3.0~3.3V ; 5	: 5.0V			
1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: B grade C: Automotive grade Y: Consumer grade 13 Option 0: Default; F: ZIF FPC; H: Hot bar FPC; D: Demo Kit	10	Touch Panel	A	N: Without touch p	anel; T: With touc	ch panel		
12 Inspection Grade 2 : B grade C : Automotive grade Y : Consumer grade 13 Option 0 : Default ; F : ZIF FPC ; H : Hot bar FPC; D : Demo Kit	11	Product type 1 : Daylight Readable 2 : Transparent OLED (TOLED) 3 : Flexible OLED (FOLED)						
	12	Inspection Gra	de	2 : B grade C : Automotive grade				
14 Serial No. Serial number(00~ZZ)	13	Option		•	•	ar FPC; D: Demo Kit		
	14	Serial No.		Serial number(00~Z	ZZ)	1000000		



3. Interface Pin Function

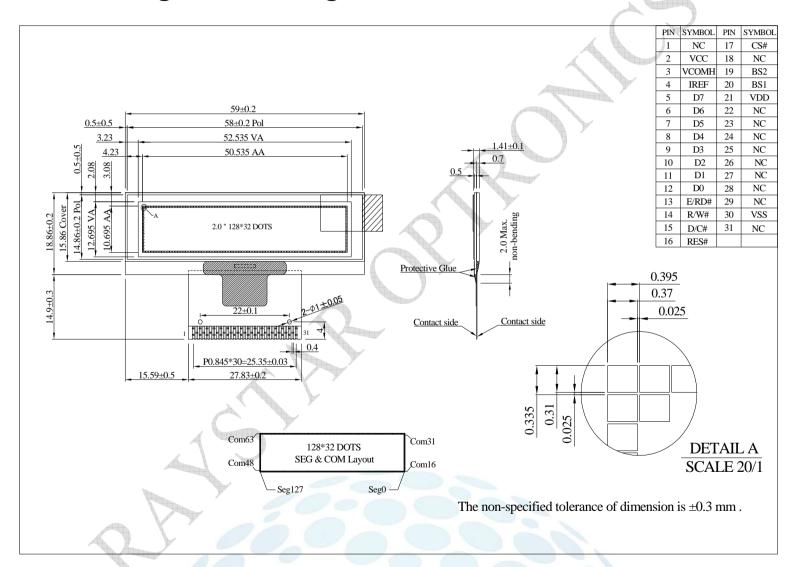
No.	Symbol	Function
1		No connection
2	VCC	Power supply for panel driving voltage. This is also the most positive power voltage supply pin. When charge pump is enabled, a capacitor should be connected between this pin and VSS.
3	VCOMH	A capacitor should be connected between this pin and v55.
4.	IREF	This is segment output current reference pin. When external IREF is used, a resistor should be connected between this pin and VSS to maintain the IREF current at 30uA.
5	D7	
6	D6	Those are 0 hit hi directional data has to be convented to the
7	D5	These are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial interface mode is selected, D0 will be
8	D4	the serial clock input: SCLK; D1 will be the serial data input: SDIN.
9	D3	When I2C mode is selected, D2, D1 should be tied together and serve as
10	D2	SDAout, SDAin in application and D0 is the serial clock input, SCL.
11	D1	pa,
12	D0	
13	E/RD#	This pin is MCU interface input. When 6800 interface mode is selected, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled HIGH and the chip is selected. When 8080 interface mode is selected, this pin receives the Read (RD#) signal. Read operation is initiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.
	1	This is read / write control input pin connecting to the MCU interface. When interfacing to a 6800-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Read mode will be carried out when this pin is pulled HIGH (i.e. connect to VDD) and write mode when LOW.
14	R/W#	When 8080 interface mode is selected, this pin will be the Write (WR#) input.
		Data write operation is initiated when this pin is pulled LOW and the chip is
		selected.
3		When serial or I2C interface is selected, this pin must be connected to VSS.
		This pin is Data/Command control pin connecting to the MCU.
4.5	D/0"	When the pin is pulled HIGH, the data at D[7:0] will be interpreted as data.
15	D/C#	When the pin is pulled LOW, the data at D[7:0] will be transferred to a command register.



16	RES#		This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin HIGH (i.e. connect to VDD) during normal operation.					
17	CS#		chip select input conn abled for MCU commu	ecting to the MCU. Inication only when CS# is pulled LOW				
18	NC	No connection						
19	BS2			elect appropriate logic setting as , BS1 and BS0 are pin select				
		BS[2:0]	Interface	A) '				
		000	4 line SPI					
		001	3 line SPI					
		010	I2C					
20	BS1	110	8-bit 8080 parallel	Y				
		100	8-bit 6800 parallel					
		Note (1) 0 is connect (2) 1 is connect	4					
21	VDD		oin for core logic opera e supply pin. It must b	ation. be connected to external source.				
22	NC							
23	NC	-						
24	NC		47					
25	NC	No connection						
26	NC							
27	NC		()					
28	NC		7 50					
29	NC							
30	VSS	Ground pin. It must be connected to external ground.						
31	NC	No connection						

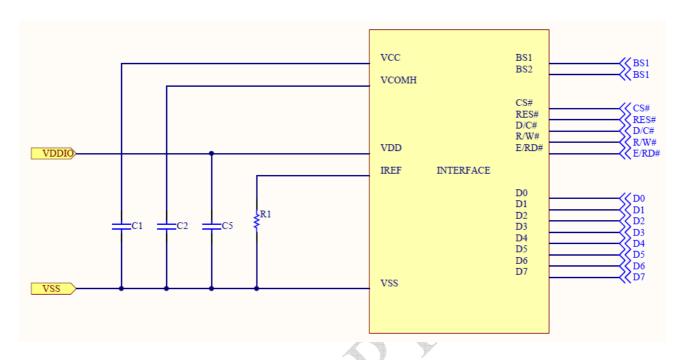


4.Contour Drawing & Block Diagram





4.1 Application recommendations



Recommended components:

C5: 1.0uF

C1, C2: 4.7uF

Bus Interface selection: (Must be set the BS[2:0], refer to item 4)

8-bits 6800 and 8080 parallel, 3 and 4-wire SPI, I2C

Voltage at IREF = VCC - 3V. For VCC = 8V, IREF = 30uA:

R1 = (Voltage at IREF - VSS) / IREF

 $= (8 - 3) / 30u \approx 166 \text{K ohm}$

^{*}For more information, please refer to Application Note provided by Raystar Optronics.



5.Absolute Maximum Ratings

Unless otherwise specified, VSS= 0V

 $(Ta = 25^{\circ}C)$

Parameter	Symbol	Min	Тур.	Max	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	1	4	V	1,2
Supply Voltage for Display	VCC	0	-	18	V	1,2
Operating Temperature	TOP	-40	-	+80	C	_
Storage Temperature	TSTG	-40	-	+85	C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.



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6.Electrical Characteristics

6.1 DC Electrical Characteristics

Unless otherwise specified, VSS = 0V, VDD = 2.8 - 3.3V (Ta = $25^{\circ}C$)

lte	ems	Symbol	Min.	Тур.	Max.	Unit
Supply	Logic	VDD	2.8	3.0	3.3	V
Voltage	Operating	VCC	7.5	8.0	8.5	V
Input	High Voltage	V_{IH}	0.8 x V _{DD}	-	VDD	V
Voltage	Low Voltage	V_{IL}	0		0.2 x VDD	V
Output	High Voltage	V_{OH}	0.9x V _{DD}	-	VDD	V
Voltage	Low Voltage	V _{OL}	0	-	0.1 x VDDIO	V

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
ICC	VCC Supply Current	-	11	22	mΔ	VDD=3V , VCC=8.0, Display 50% ON



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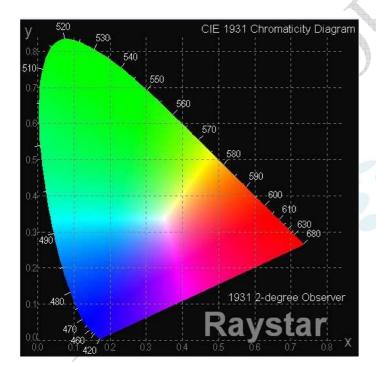
6.2 Initial code

```
void init oled()
 Write_Command(0xAE); // Display Off
 Write_Command(0xD5);
                         //SET DISPLAY CLOCK
 Write Command(0xF0);
                         //105HZ
 Write Command(0xA8);
                         // Select Multiplex Ratio
 Write_Command(0x1F);
 Write Command(0xD3): //Setting Display Offset
 Write Command(0x00);
                         //00H Reset
 Write Command(0x40);
                         //Set Display Start Line
 Write Command(0x8D); // Set Charge Pump
 Write Command(0x10):
                         // Endable Charge Pump
 Write_Command(0xA1); //Set Segment Re-Map Default
                        //0xA0 (0x00) => column Address 0 mapped to 127
                        //0xA1 (0x01) => Column Address 127 mapped to 0
 Write_Command(0xC8); //Set COM Output Scan Direction
                        // 0xC0 (0x00) => normal mode (RESET) Scan from COM0 to
                        COM[N-1]:Where N is the Multiplex ratio.
                        // 0xC8 (0xC8) => remapped mode. Scan from COM[N-1] to
                        COM0::Where N is the Multiplex ratio.
 Write Command(0xDA); //Set COM Hardware Configuration
 Write_Command(0x12);
                         //Alternative COM Pin---See IC Spec page 34
                        //(0x02)=> A4=0; Sequential COM pin configuration;
                        A5=0; Disable COM Left/Right remap
 Write Command(0x81); //Set Contrast Control
 Write_Command(0xFF);
 Write_Command(0xD9); //Set Pre-Charge period
 Write_Command(0x22);
 Write Command(0xDB); //Set Deselect Vcomh level
 Write_Command(0x30);
 Write_Command(0xD3);
                         //OFFSET
  Write Command(32);
 Write Command(0xA4): //Entire Display ON
 Write Command(0xA6); //Set Normal Display
 Write Command(0xAF); // Display ON
```



7. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Maria Arabia	(V)θ	_	160	_	-	deg
View Angle	(Η)φ	_	160	_	1	deg
Contrast Ratio	CR	Dark	2000:1	- 4	-	_
	T rise	_	_	10		μs
Response Time	T fall	_		10		μs
Display with 50%	Display with 50% check Board Brightness					cd/m2
CIEx(White	e)	(CIE1931)	0.26	0.28	0.30	_
CIEy(White	э)	(CIE1931)	0.30	0.32	0.34	_





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8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25℃ / Initial 50% check board brightness Typical Value	20,000 Hrs	-	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.





9.Reliability

Environmental Test				
Test Item	Content of Test	Test Condition	Applicable Standard	
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85℃ 240hrs	-	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40℃ 240hrs		
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80℃ 240hrs		
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40℃ 240hrs		
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60℃,90%RH 240hrs		
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60℃,90%RH 120hrs		
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40° 25° 80°		286	
Mechanical Tes	st C			
Vibration test Endurance test applying the vibration during transportation and using.		Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z		
Others	7 70			
Static electricity test	Endurance test applying the electric stress to the terminal.	Air Discharge model ±4kv,10 times		

^{***} Supply voltage for OLED system =Operating voltage at 25°C



Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5℃; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

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Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



10.Inspection specification

Inspection Standard:

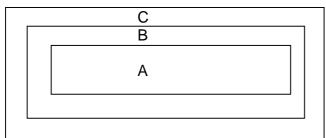
MIL-STD-105E table normal inspection single sample level II.

Definition

1 Major defect: The defect that greatly affect the usability of product.

2 Minor defect: The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

Inspection Methods

1 The general inspection : Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5℃.

2 The luminance and color coordinate inspection : By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5℃.

NO	Item	Criterion	AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 	0.65
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≤ 0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm. 	2.5



NO	Item	Criterion			AQL	
	OLED black spots, white spots, contamin ation (non-display)	3.1 Round type : As following drawing Φ=(x+y)/2 → X	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable QTY Accept no dense 2 1 0	Zone A+ B, A+ B A+ B	2.5
03		3.2 Line type : (As the second	n Width W≦0.02	Acceptable Q TY Accept no dense	Zone A+B	2.5
		L≦3.0 L≦2.5	5 0.03 < W ≤ 0.0)5	A+B A+B	
			0.05 < W	As round type		
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications,	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$	Acceptable Q TY Accept no dense 3 2	Zone A+B A+B	2.5
		not easy to find,	0.50<Φ≦1.00 1.00<Φ	0	A+B A+B	2.0
		must check in specify direction.	Total Q TY	3	Arb	
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination.				



NO	Item	Criterion	
	Chipped glass	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:	2.5
06	giass	6.1.2 Corner crack: z: Chip thickness y: Chip width x: Chip length $Z \le 1/2t$ Not over viewing area $X \le 1/8a$ $1/2t < z \le 2t$ Not exceed $1/3k$ $X \le 1/8a$ $Old the color of the chip.$	2.5
	Glass	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.5



NO	Item	Criterion		
06	Glass crack	6.2.2 Non-conductive portion: y: Chip width x: Chip length z: Chip thickness $y \le L$ $x \le 1/8a$ $0 < z \le t$ \odot If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. \odot If the product will be heat sealed by the customer, the alignment mark not be damaged. 6.2.3 Substrate protuberance and internal crack. x y : width x : length $y \le 1/3L$ $x \le a$	2.5	
07	Cracked glass	The OLED with extensive crack is not acceptable.		
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 		
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.		



NO	Item	Criterion	AQL
	PCB , COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.10.3 The height of the COB should not exceed the height indicated in the assembly diagram.	2.5 0.65
		10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.	2.5
10		 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 	2.5 0.65
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB.11.2 No cold solder joints, missing solder connections, oxidation	2.5 2.5
		or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 0.65
		12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
	4	12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product.	0.65 2.5
12	General	12.4 The IC on the TCP may not be damaged, circuits.12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.	2.5 2.5
	appearance	12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.12.8 Pin type must match type in specification sheet.	2.5 0.65
		12.9 OLED pin loose or missing pins.12.10 Product packaging must the same as specified on packaging specification sheet.	0.65 0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.65



Check Item	Classification	Criteria			
No Display	Major				
Missing Line	Major				
Pixel Short	Major				
Darker Short	Major				
Wrong Display	Major				
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Fixel C Dish Fixel			



11.Precautions in use of OLED Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist OLED display module.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9) Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time.
- (10) Raystar has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) Raystar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Raystar have the right to modify the version.)

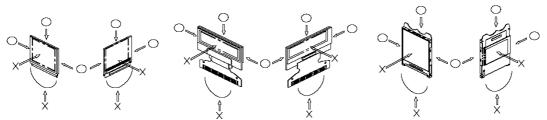
11.1 Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
- * Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.





- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
- (11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

11.2 Storage Precautions

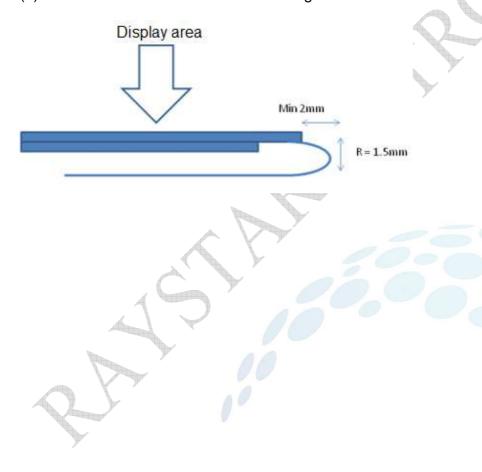
- (1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. And, also, avoiding high temperature and high humidity environment or low temperature (less than 0℃) environments.(We recommend you to store these modules in the packaged state when they were shipped from Raystar Optronics Inc. At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- (2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.





11.3 Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module. Connection (contact) to any other potential than the above may lead to rupture of the IC.
- (8) The limitation of FPC and Film bending.





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raye. I				
Module Sample Estimate Feedback Sheet				
Module Number:				
1 · Panel Specification :				
1. Panel Type:	□ Pass	□NG ,		
2. Numbers of Pixel:	□ Pass	□NG ,		
3. View Area:	□ Pass	□NG ,		
4. Active Area:	□ Pass	□NG ,		
5.Emitting Color:	□ Pass	□NG ,		
6.Uniformity:	□Pass	□NG ,		
7.Operating	□ Pass	□NG ,		
Temperature :				
8.Storage Temperature:	□ Pass	□NG ,		
9.Others:				
2 · Mechanical Specificati	<u>on</u> :			
1. PCB Size:	□Pass	□NG ,		
2.Frame Size :	□Pass	□NG ,		
3.Materal of Frame:	□Pass	□NG ,		
4.Connector Position:	□Pass	□NG ,		
5.Fix Hole Position:	□Pass	□NG ,		
6. Thickness of PCB:	□Pass	□NG ,		
7. Height of Frame to	□Pass	□NG ,		
PCB:				
8.Height of Module:	□Pass	□NG ,		
9.Others:	□Pass	□NG ,		
3 · Relative Hole Size :				
1.Pitch of Connector:	□Pass	□NG ,		
2.Hole size of □Pass		□NG ,		
Connector:				
3.Mounting Hole size:	□Pass	□NG ,		
4.Mounting Hole Type:	□Pass	□NG ,		
5.Others:	□Pass	□NG ,		

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Module Number :				
4 · Electronic Characteristic	s of Modul	<u>e</u> :		
1.Input Voltage:	□Pass	□NG ,		
2.Supply Current:	□Pass	□NG ,		
3.Driving Voltage for OLED:	□Pass	LING,		
4.Contrast for OLED:	□Pass	□NG ,		
5.Negative Voltage Output:	□Pass	□NG ,		
6.Interface Function:	□Pass	□NG ,		
7.ESD test:	□Pass	□NG ,		
8.Others:	□Pass	□NG ,		
Sales signature :				
Customer Signature : Date : / /				